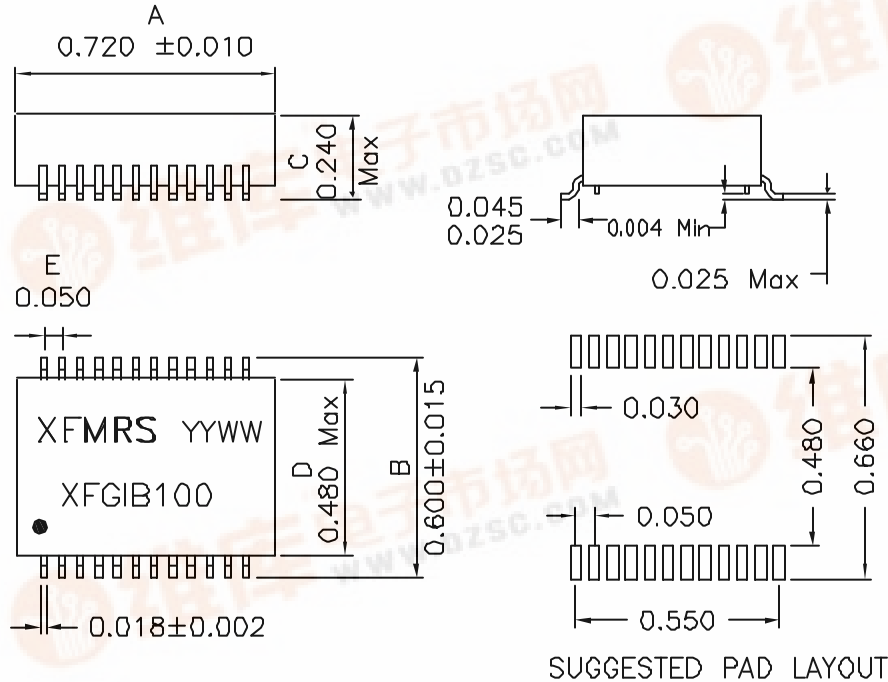


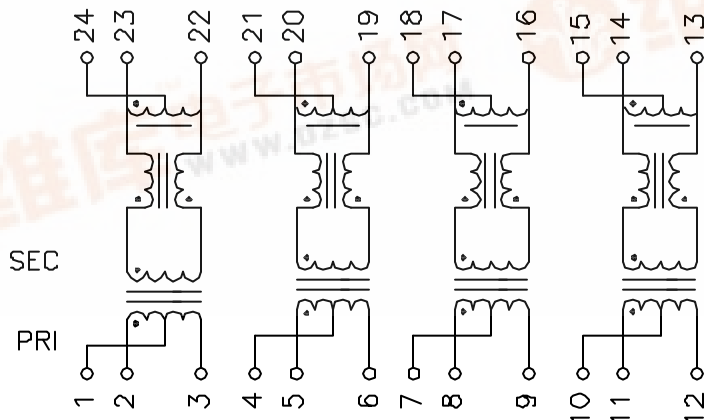
1. Mechanical Dimensions:



3. Electrical Specifications: @25°C

ISOLATION: 1500 Vrms
 TURNS RATIO: (PRI/SEC) 1CT:1CT ±2%
 OCL: 350uH MIN @100KHz 100mV 8mADC
 Rise Time: 1.75ns Max.
 INSERTION LOSS: -1.0dB MAX @1MHz-100MHz
 RETURN LOSS: -18dB Min @1-30MHz
 -15dB Min @40MHz -13.1dB Min @50MHz
 -12dB Min @60-80MHz -10dB Min @100MHz
 Differential to Common Mode Rejection:
 -43dB Min @30MHz -37dB Min @80MHz
 -33dB Min @100MHz
 CMRR: -30dB Min @1-100MHz
 Crosstalk: -45dB Min @30MHz
 -40dB Min @60MHz -35dB Min @100MHz

2. Schematic:



Notes:

- Solderability: Leads shall meet MIL-STD-202, Method 208D for solderability.
- Flammability: UL94V-0
- ASTM oxygen index: > 28%
- Insulation System: Class F 155°C. UL file E151556
- Operating Temperature Range: All listed parameters are to be within tolerance from -40°C to +85°C
- Storage Temperature Range: -55°C to +125°C
- Aqueous wash compatible
- SMD Lead Coplanarity: ±0.004" (0.102mm)
- Moisture Sensitivity: Level 3
- Electrical and mechanical specifications 100% tested
- RoHS Compliant Component

XFMRS Inc		Title: 1000BASE-T Modules	
UNLESS OTHERWISE SPECIFIED TOLERANCES: .xxx ±0.010 Dimensions in INCH	P/N: XFGIB100	REV. A	
	DWN.	Juan Mao	Sep-12-04
	CHK.	YK Liao	Sep-12-04

